

March 2012
SuperFET® II

# FCP380N60E / FCPF380N60E 600V N-Channel MOSFET

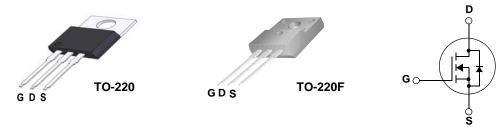
#### **Features**

- 650V @T<sub>.1</sub> = 150°C
- Max.  $R_{DS(on)} = 380 m\Omega$
- Ultra Low Gate Charge (Typ.  $Q_g = 34nC$ )
- Low Effective Output Capacitance (Typ. C<sub>oss</sub>.eff = 97pF)
- 100% Avalanche Tested

## **Description**

SuperFET<sup>®</sup>II is, Fairchild's proprietary, new generation of high voltage MOSFET family that is utilizing an advanced charge balance mechanism for outstanding low on-resistance and lower gate charge performance.

This advanced technology has been tailored to minimize conduction loss, provide superior switching performance, and withstand extreme dv/dt rate and higher avalanche energy. Consequently, SuperFET®II is very suitable for various AC/DC power conversion in switching mode operation for system miniaturization and higher efficiency.



## MOSFET Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted

Symbol		Parameter		FCP380N60E	FCPF380N60E	Units
V <sub>DSS</sub>	Drain to Source Voltage			600		V
V	Cata ta Cauraa Valtaga	- DC		±	:20	V
V <sub>GSS</sub> Gate to Source Voltage		- AC	(f > 1Hz)	±	:30	V
1	Drain Current	-Continuous (T <sub>C</sub> = 25°C)		10.2	10.2*	٨
I <sub>D</sub>	Drain Current	-Continuous (T <sub>C</sub> = 100°C)		6.4	6.4*	Α
I <sub>DM</sub>	Drain Current - Pulsed (Note		(Note 1)	1) 30.6 30.6*		Α
E <sub>AS</sub>	Single Pulsed Avalanche Energy		(Note 2)	2) 211.6		mJ
I <sub>AR</sub>	Avalanche Current		(Note 1)	1) 2.3		Α
E <sub>AR</sub>	Repetitive Avalanche Energy		(Note 1)	1) 1.06		mJ
dv/dt	Peak Diode Recovery dv/dt		(Note 3)	3) 20		V/ns
αν/αι	MOSFET dv/dt			1	00	V/IIS
D	Dower Discinstian	(T <sub>C</sub> = 25°C)		106	31	W
$P_{D}$	Power Dissipation	- Derate above 25°C		0.85	0.25	W/oC
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range		-55 to +150		οС	
T <sub>L</sub>	Maximum Lead Temperature 1/8" from Case for 5 Seconds	• •		3	600	οС

<sup>\*</sup>Drain current limited by maximum junction temperature

## **Thermal Characteristics**

Symbol	Parameter	FCP380N60E	FCPF380N60E	Units
$R_{\theta JC}$	Thermal Resistance, Junction to Case	1.18	4	
$R_{\theta CS}$	Thermal Resistance, Case to Heat Sink (Typical)	0.5	0.5	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	62.5	62.5	

# **Package Marking and Ordering Information**

Ī	Device Marking	Device	Package	Reel Size	Tape Width	Quantity
Ī	FCP380N60E	FCP380N60E	TO-220	-	-	50
Ī	FCPF380N60E	FCPF380N60E	TO-220F	=	=	50

# **Electrical Characteristics** $T_C = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
Off Charac	cteristics					
D\/	Drain to Source Breakdown Voltage	$V_{GS} = 0V, I_D = 10mA, T_J = 25^{\circ}C$	600	-	-	V
Drain to Source Breakdown \	Dialii to Source Breakdown voltage	$V_{GS} = 0V, I_D = 10mA, T_J = 150^{\circ}C$	650	-	-	V
$\frac{\Delta BV_{DSS}}{\Delta T_{J}}$	Breakdown Voltage Temperature Coefficient	I <sub>D</sub> = 10mA, Referenced to 25°C	-	0.67	-	V/°C
BV <sub>DS</sub>	Drain-Source Avalanche Breakdown Voltage	$V_{GS} = 0V, I_D = 10A$	-	700	=	V
	Zero Gate Voltage Drain Current	$V_{DS} = 480V, V_{GS} = 0V$	-	-	1	
IDSS	Zero Gate voltage Drain Current	$V_{DS} = 480V, T_{C} = 125^{\circ}C$	-	-	10	μΑ
I <sub>GSS</sub>	Gate to Body Leakage Current	$V_{GS} = \pm 20V, V_{DS} = 0V$	-	-	±100	nA

#### **On Characteristics**

V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \mu A$	2.5	-	3.5	V
R <sub>DS(on)</sub>	Static Drain to Source On Resistance	$V_{GS} = 10V, I_D = 5A$	-	0.32	0.38	Ω
9 <sub>FS</sub>	Forward Transconductance	$V_{DS} = 20V, I_{D} = 5A$	-	10		S

## **Dynamic Characteristics**

C <sub>iss</sub>	Input Capacitance	)/ OF)/ )/ O)/	-	1330	1770	pF
C <sub>oss</sub>	Output Capacitance	$V_{DS} = 25V, V_{GS} = 0V$ f = 1MHz	-	945	1260	pF
C <sub>rss</sub>	Reverse Transfer Capacitance	I = IIVIDZ		60	90	pF
C <sub>oss</sub>	Output Capacitance	$V_{DS} = 380V, V_{GS} = 0V, f = 1.0MHz$	-	25	-	pF
Coss eff.	Effective Output Capacitance	$V_{DS} = 0V$ to 480V, $V_{GS} = 0V$	-	97	-	pF
Q <sub>g(tot)</sub>	Total Gate Charge at 10V		-	34	45	nC
Q <sub>gs</sub>	Gate to Source Gate Charge	$V_{DS} = 380V, I_{D} = 5A$	-	5.3	-	nC
Q <sub>gd</sub>	Gate to Drain "Miller" Charge	V <sub>GS</sub> = 10V (Note 4)	-	13	-	nC
ESR	Equivalent Series Resistance	Drain open	-	6	-	Ω

### **Switching Characteristics**

t <sub>d(on)</sub>	Turn-On Delay Time		-	17	44	ns
t <sub>r</sub>		$V_{DD} = 380V, I_{D} = 5A$	-	9	28	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	$V_{GS} = 10V, R_G = 4.7\Omega$	-	64	138	ns
t <sub>f</sub>	Turn-Off Fall Time	(Note 4)	-	10	30	ns

#### **Drain-Source Diode Characteristics**

$I_S$	Maximum Continuous Drain to Source Diod	Maximum Continuous Drain to Source Diode Forward Current			10.2	Α
I <sub>SM</sub>	Maximum Pulsed Drain to Source Diode Forward Current		-	-	30.6	Α
$V_{SD}$	Drain to Source Diode Forward Voltage	$V_{GS} = 0V$ , $I_{SD} = 5A$	-	-	1.2	V
t <sub>rr</sub>	Reverse Recovery Time	$V_{GS} = 0V$ , $I_{SD} = 5A$	-	240	-	ns
Q <sub>rr</sub>	Reverse Recovery Charge	$dI_F/dt = 100A/\mu s$	-	3	-	μС

#### Notes:

- ${\bf 1.}\ {\bf Repetitive}\ {\bf Rating:}\ {\bf Pulse}\ {\bf width}\ {\bf limited}\ {\bf by}\ {\bf maximum}\ {\bf junction}\ {\bf temperature}$
- 2. I $_{AS}$  = 2.3A, V $_{DD}$  = 50V, R $_{G}$  = 25 $\Omega$ , Starting T $_{J}$  = 25°C
- 3.  $I_{SD} \le 5.1 A$ , di/dt  $\le 200 A/\mu s$ ,  $V_{DD} \le BV_{DSS}$ , Starting  $T_J = 25^{\circ}C$
- 4. Essentially Independent of Operating Temperature Typical Characteristics

## **Typical Performance Characteristics**

Figure 1. On-Region Characteristics

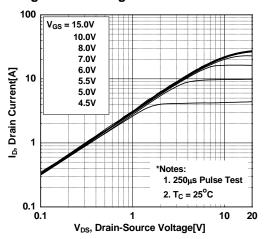


Figure 3. On-Resistance Variation vs.

Drain Current and Gate Voltage

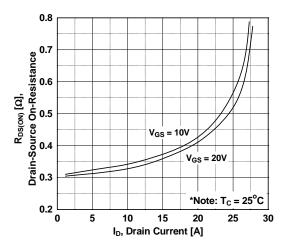


Figure 5. Capacitance Characteristics

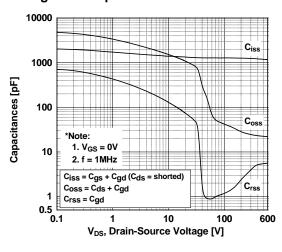


Figure 2. Transfer Characteristics

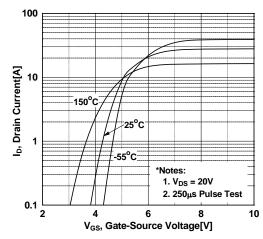


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

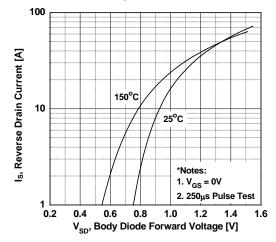
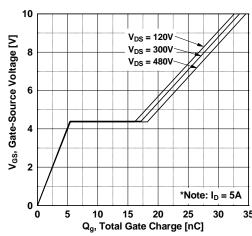


Figure 6. Gate Charge Characteristics



## **Typical Performance Characteristics** (Continued)

Figure 7. Breakdown Voltage Variation vs. Temperature

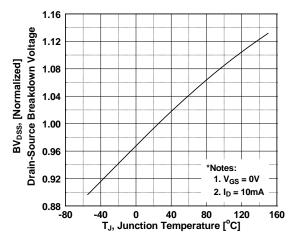
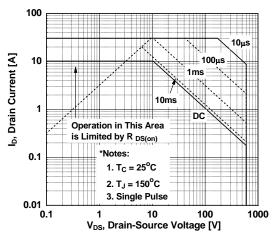


Figure 9. Maximum Safe Operating Area vs. Case Temperature - FCP380N60E



**Figure 11. Maximum Drain Current** 

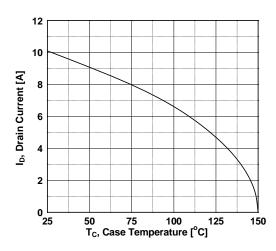


Figure 8. On-Resistance Variation vs. Temperature

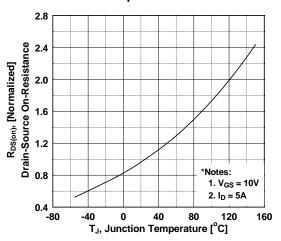


Figure 10. Maximum Safe Operating Area vs. Case Temperature - FCPF380N60E

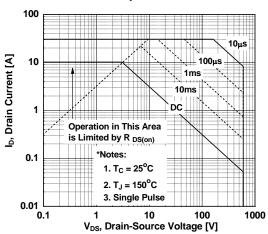
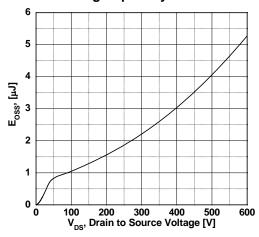


Figure 12. Eoss vs. Drain to Source Voltage Switching Capability



## **Typical Performance Characteristics** (Continued)

Figure 13. Transient Thermal Response Curve - FCP380N60E

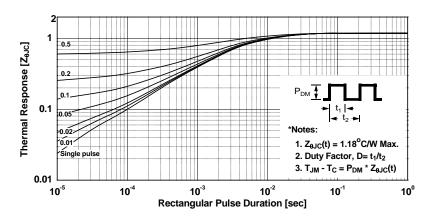
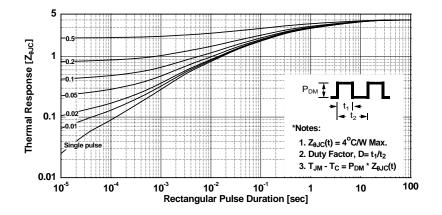
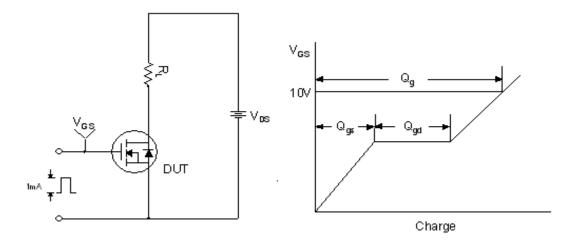


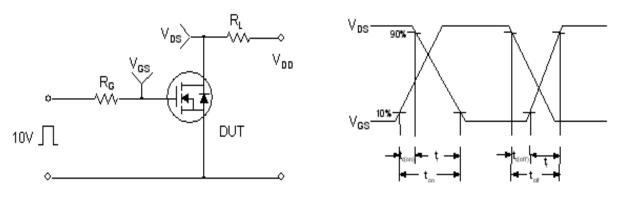
Figure 14. Transient Thermal Response Curve - FCPF380N60E



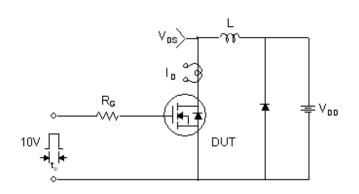
### **Gate Charge Test Circuit & Waveform**

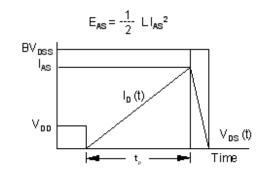


### **Resistive Switching Test Circuit & Waveforms**

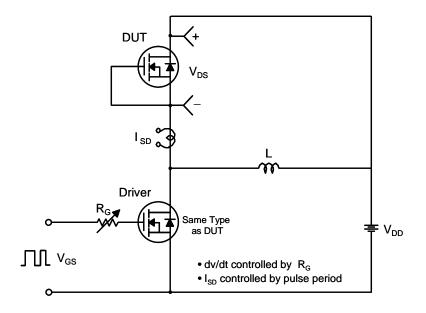


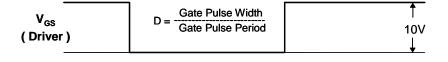
**Unclamped Inductive Switching Test Circuit & Waveforms** 

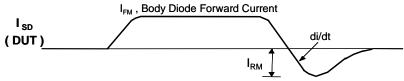




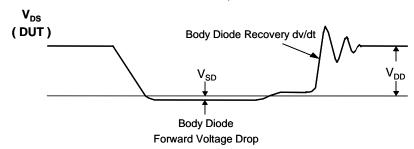
#### Peak Diode Recovery dv/dt Test Circuit & Waveforms





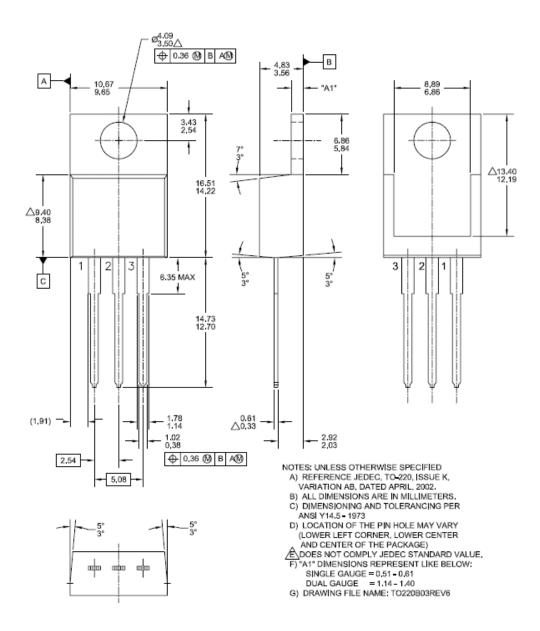


Body Diode Reverse Current



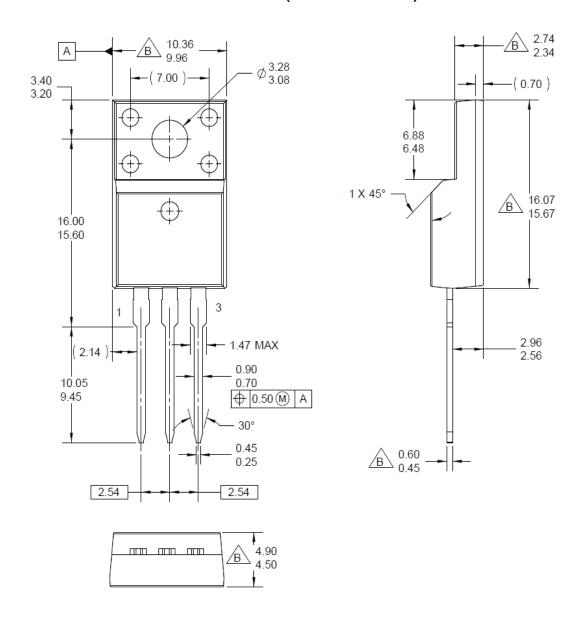
### **Mechanical Dimensions**

# **TO-220AB**



## **Package Dimensions**

# TO-220F (Retractable)



\* Front/Back Side Isolation Voltage : AC 2500V

Dimensions in Millimeters





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FCP380N60E / FCPF380N60E Rev. C4

Datasheet Identification	Product Status	Definition
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
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